## Si2387DS

**RoHS** 

COMPLIANT

HALOGEN

FREE

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Marking code: G8

V<sub>DS</sub> (V)

Q<sub>g</sub> typ. (nC)

Configuration

I<sub>D</sub> (A) a, e

**PRODUCT SUMMARY** 

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 10 V

 $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 4.5 V

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-80

0.164

0.242

6.7

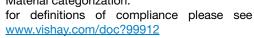
-3.0

Single

#### **FEATURES**

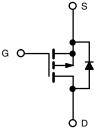
P-Channel 80 V (D-S) MOSFET

- TrenchFET<sup>®</sup> Gen IV p-channel power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization:



#### **APPLICATIONS**

- · Load switch
- Circuit protection
- Motor drive control



P-Channel MOSFET

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	SI2387DS-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b>	$(T_A = 25 \ ^\circ C, unles)$	ss otherwise	e noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage	V <sub>DS</sub>	-80	N	
Gate-source voltage	V <sub>GS</sub>	± 20	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-3.0 <sup>e</sup>	
	T <sub>C</sub> = 70 °C	1 . [	-2.4	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-2.1 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		-1.7 <sup>b, c</sup>	А
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-10	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-2.1	
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-1.1 <sup>b, c</sup>	
Maximum power dissipation	T <sub>C</sub> = 25 °C		2.5	
	T <sub>C</sub> = 70 °C		1.6	w
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.3 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C	1 1	0.8 <sup>b, c</sup>	
Operating junction and storage temperature ra	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient <sup>b</sup>	t ≤ 5 s	R <sub>thJA</sub>	75	100	°C/W	
Maximum junction-to-case (drain)	Steady5 state	R <sub>thJF</sub>	40	50	C/W	

#### Notes

- a. Based on  $T_C = 25 \ ^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 166 °C/W
- e. Package limited

S22-0137-Rev. B, 14-Feb-2022

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-80	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$			-24.7	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.7	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	-1.5	-	-2.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20$	-	-	100	nA
	I <sub>DSS</sub>	$V_{DS} = -80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ -		-	-1	
Zero gate voltage drain current		$V_{DS}$ = -80 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C	-	-	-15	5 µA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-10	-	-	Α
	D	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -2.1 A	-	0.137	0.164	Ω
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -1.7 A	-	0.202	0.242	
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -2.1 A	-	5	-	S
Dynamic <sup>b</sup>				•	•	
Input capacitance	C <sub>iss</sub>		-	395	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	155	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	7	-	
Total gate charge	Qg	$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.1 \text{ A}$	-	6.8	10.2	nC
			-	3.2	4.8	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -40 V, $V_{GS}$ = -4.5 V, $I_D$ =2.1 A	-	1.8	-	
Gate-drain charge	Q <sub>gd</sub>		-	0.85	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.1	5.5	11	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> = -40 V, R <sub>L</sub> = 23.5 Ω, I <sub>D</sub> ≅ -1.7 A,	-	5	10	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -10 V, $R_g$ = 1 $\Omega$	-	22	44	
Fall time	t <sub>f</sub>		-	13	26	
Turn-on delay time	t <sub>d(on)</sub>		-	25	50	
Rise time	t <sub>r</sub>	$V_{DD} = -40 \text{ V}, \text{ R}_{L} = 23.5 \Omega, \text{ I}_{D} \cong -1.7 \text{ A},$	-	20	40	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	22	44	
Fall time	t <sub>f</sub>		-	15	30	
Drain-Source Body Diode Characterist	cs					
Continuous source-drain diode current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-2.1	_
Pulse diode forward current	I <sub>SM</sub>		-	-	-10	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -1.7 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>	· • • •	-	18	36	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -4.8 A, di/dt = 100 A/μs,	-	15	30	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	13	- 1	
-	š			5	1	ns

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

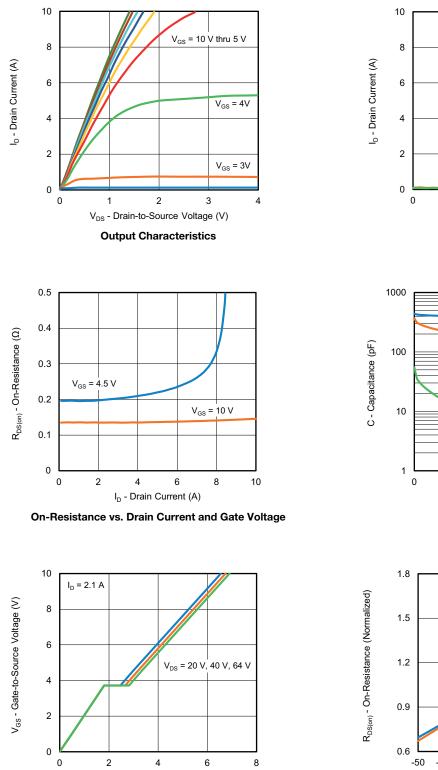
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

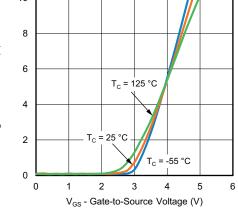
2



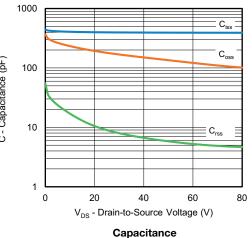
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

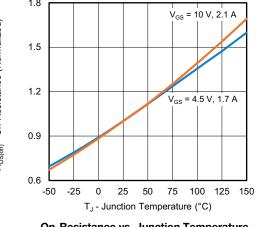




**Transfer Characteristics** 







**On-Resistance vs. Junction Temperature** 

S22-0137-Rev. B, 14-Feb-2022

Q<sub>g</sub> - Total Gate Charge (nC)

Gate Charge

3

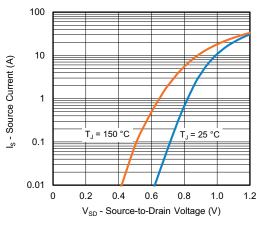
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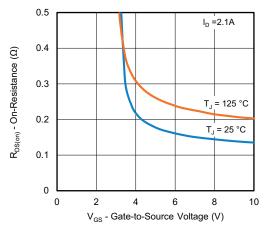


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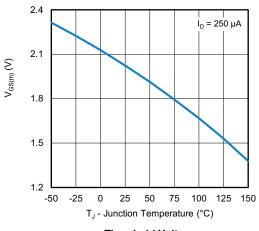
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



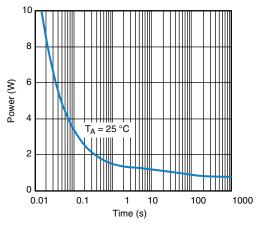
Source-Drain Diode Forward Voltage



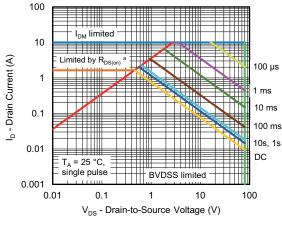
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

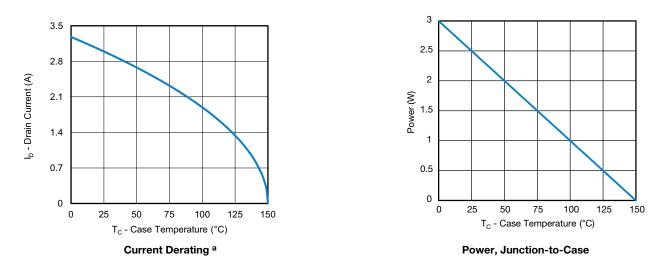
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# Si2387DS

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Note

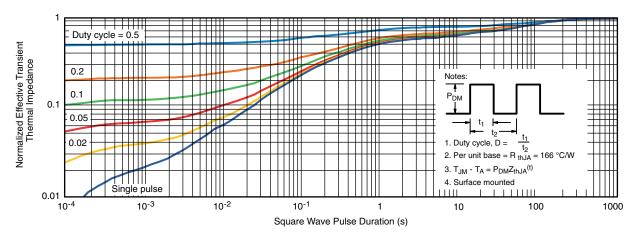
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



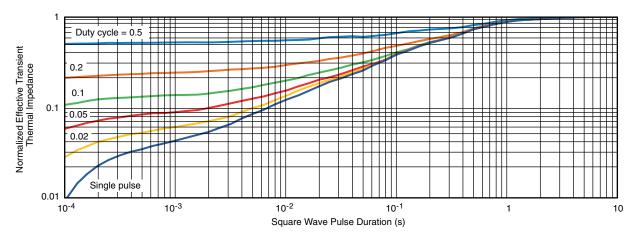
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

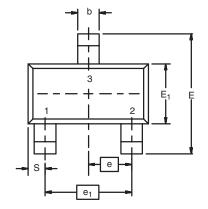
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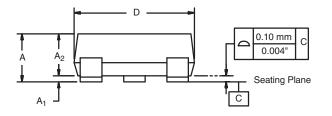


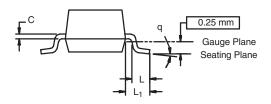
# Package Information

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### SOT-23 (TO-236): 3-LEAD





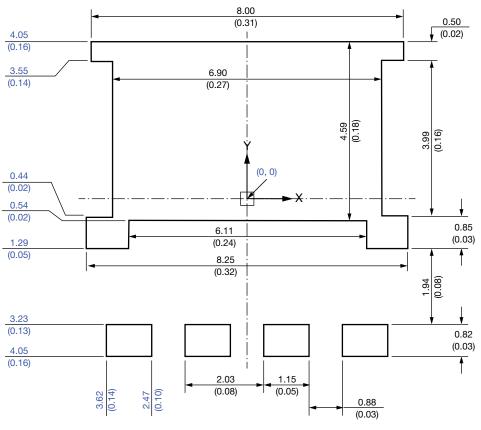


Dim	MILLIN	IETERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01				



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# **Recommended Minimum PADs for PowerPAK® 8 x 8L Single**



Dimensions in millimeters (inches)

#### Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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